DECLARATION IN SUPPORT OF PATENT APPLICATION (Division, Continuation, or C-I-P)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the invention entitled:

SYSTEM AND METHOD FOR MOLDING A BASKETBALL BACKBOARD

described and claimed

X	in the attached specification;	
	in the specification filed	
	as U.S. Application Serial No.	
	and as amended	•

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims as filed and as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I acknowledge an assignment of my entire interest in the above invention to Modern Technologies Corp., and I hereby direct that all communications concerning this application be sent to the Assignee's Attorneys:

JACOX, MECKSTROTH & JENKINS 2310 Far Hills Building Dayton, Ohio 45419-1575

I hereby claim the benefit under Title 35, United States Code, \$120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, \$112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, \$1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Filing Date

Status

08/220.906

March 31, 1994

Pending

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under \$1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole or first Inventor: FREDRIC LOUIS ABRAMS

Inventor'	s

Residence: 415 Kramer Road, Dayton, Ohio 45419-3311

Citizenship: U.S.A.

Post Office Address: c/o Modern Technologies Corp.

4032 Linden Avenue, Dayton, Ohio 45432

Full name of second Inventor: ROBERT F. FREUND

Inventor's

signature_

Residence:

1360 Timber Ridge, Dayton, Ohio

Citizenship: U.S.A.

Post Office Address: c/o Modern Technologies Corp.

4032 Linden Avenue, Dayton, Ohio 45432

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

Inventor(s)

Fredric L. Abrams

Robert F. Freund

Serial No.

09/399.524

Filed

September 20, 1999

Title

METHOD FOR FORMING A MOLTEN BILLET

Group

1732

Examiner

M. Eashoo

Docket

MTY 065 P2 CI

Assistant Commissioner for Patents

Washington, D. C. 20231

Sir:

CERTIFICATE UNDER 37 CFR 3.73(b)

Composite Technologies Co., LLC, a corporation of the State of Ohio, certifies that it is the Assignee of the entire right, title and interest in the patent application identified above by virtue of an Assignment from the Applicant(s) for the patent application identified above, a copy of which is attached.

The undersigned has reviewed the Assignment of the patent application identified above and, to the best of undersigned's knowledge and belief, title is in the Assignee identified above.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the Assignee.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under §1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: David S. Gutridge

ASSIGNMENT OF UNITED STATES APPLICATIONS AND LETTERS PATENTS

WHEREAS, Modern Technologies Corp., a corporation of the State of Ohio, having a principal place of business at 4032 Linden Avenue, Dayton, Ohio 45432 (hereinafter the Assignor), is the owner of the entire right, title and interest in and to the following applications for United States Letters Patent and the inventions therein contained, and is the owner of the entire right, title and interest in and to the following United States Letters Patents, and the inventions therein contained:

ř.	Country	Serial No.	<u>Filed</u>	Inventor	<u>Title</u>
	US	09/399,524	09-20-1999	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD OF CREATING A MOLTEN BILLET
	Australia	17336/99	02-16-1999	Fredric L. Abrams Robert F. Freund	PLASTICATOR AND SYSTEM FOR MOLDING A PART
	Canada	2,185,809	03-14-1995	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING PARTS
	Canada	2,265,784	06-20-1997	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING A BASKETBALL BACKBOARD
	EPO	95 914 028.6	03-14-1995	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING PARTS
	EPO	97 931 315.2	06-20-1997	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING A BASKETBALL BACKBOARD
	India	307/CAL/95	03-20-1995	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING PARTS
	Country	Patent No.	<u>Issued</u>	Inventors	<u>Title</u>
	US	5,591,384	01/071997	Fredric L. Abrams Robert F. Freund	METHOD FOR MOLDING PARTS
	US	5,637,329	06/10/1997	Fredric L. Abrams Robert F. Freund	PLASTICATOR AND SYSTEM FOR MOLDING PARTS
	US	5,800,757	09/01/1998	Robert F. Freund Fredric L. Abrams	SYSTEM AND METHOD FOR MOLDING A BASKETBALL BACKBOARD
	Australia	699,303	03/14/95	Fredric L. Abrams Robert F. Freund	SYSTEM AND METHOD FOR MOLDING PARTS
	Taiwan	076,469	03/17/95	Fredric L. Abrams Robert F. Freund	METHOD FOR MOLDING PARTS

AND, WHEREAS, COMPOSITE TECHNOLOGIES CO., LLC, a Limited Liability Company of the State of Ohio, having a principal place of business at 33 W. First Street, Dayton, Ohio 45402, (hereinafter the Assignee), is desirous of acquiring the entire right, title and interest in and to said applications and the inventions therein disclosed and any letters patent that may issue thereon, and is desirous of acquiring the entire right, title and interest in and to said United States Letters Patents and the inventions therein contained;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable considerations, receipt of which is hereby acknowledged, the Assignor hereby sells, assigns and transfers to the Assignee, its successors and assigns, the entire right#, title and interest in and to the aforementioned United States application for letters patents and the inventions therein contained, and the entire right, title and interest in and to the aforementioned United States Letters Patents and the inventions therein contained, including any divisions, continuations, extensions, foreign applications or reissues thereof, together with all rights of recovery for past infringements thereof; and said Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any reissues or extensions thereof to said Assignee, its successors and assigns, the same to be held and enjoyed by said Assignee, its successors and assigns, to the full end of the term for which said Letters Patents are granted and as fully and entirely as the same would have been enjoyed by the said Assignor had this sale, assignment and transfer not been made; and we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and we hereby agree that, upon request, we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with the said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

THIS AGREEMENT supersedes any and all prior Agreements and licenses between Modern Technologies Corp. and Composite Technologies Co., LLC.

IN WITNESS WHEREOF, the Assignor has hereunto set its hand and seal as of the 13th day of March, 2000.

MODERN TECHNOLOGIES CORP.

David S. Gutridge, President
Vice-President

State of Ohio

SS

County of Montgomery

Notary Public

MARILYN A. McINTOSH, Notary Public In and for the State of Ohio

My Commission Expires Sept. 27 2000

POWER OF ATTORNEY

Whereas Composite Technologies Co., LLC, a limited liability company of the State of Chio having a place of business at 33 W. First Street, Dayton, OH 45402, is the owner by assignment of the entire right, title and interest in and to United States Patent Application entitled SYSTEM AND METI IOD FOR MOLDING A BASKETBALL BACKBOARD (Docket No. MTY 065 P2 CI-2), which Application is a Continuation of U. S. Patent Application Serial No. 09/399,524 filed September 20, 1999, and of the Inventions described and claimed therein:

Composite Technologies Co., LLC. hereby appoints:

Matthew R. Jenkins Reg. No. 34,844 Alan F. Meckstroth Reg. No. 22,507

Gregory A. Welte Reg. No. 30,434

its attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. Address all telephone calls to (937) 298-2811.

Address all correspondence to: JACOX, MECKSTROTH & JENKINS 2310 Far Hills Building, Dayton, Ohio 45419-1575.

COMPOSITE TECHNOLOGIES CO., LLC